

N-Channel Silicon MOSFET - General-Purpose Switching Device Applications

Features

- The SCH2401 incorporates two elements in the same package which are N-channel MOSFETs, thereby enabling high-density mounting.
- Low ON-resistance.
- High-speed switching.
- 2.5V drive.
- High ESD voltage (TYP 300V) [Built-in one side diode for protection between Gate-to-Source].

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	V
Gate-to-Source Voltage (*1)	VGSS		10	V
Drain Current (DC)	۱ _D		0.7	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	2.8	А
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm ² ×0.8mm) 1unit	0.65	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

(*1): Since the diode between Gate-to-Source for gate prevention serves as one side direction, this product should be careful in circuitry.

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions		Ratings		
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =30V, V _{GS} =0V			1	μA
Gate-to-Source Leakage Current	IGSS	V _{GS} =8V, V _{DS} =0V			1	μΑ
Cutoff Voltage	VGS(off)	VDS=10V, ID=100μA	0.4		1.3	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =350mA	0.48	0.8		S
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=350mA, VGS=4V		0.7	0.9	Ω
	RDS(on)2	ID=200mA, VGS=2.5V		0.8	1.15	Ω
	R _{DS} (on)3	ID=10mA, VGS=1.5V		1.6	2.4	Ω
Input Capacitance	Ciss	VDS=10V, f=1MHz		30		pF
Output Capacitance	Coss	V _{DS} =10V, f=1MHz		7		pF
Reverse Transfer Capacitance	Crss	V _{DS} =10V, f=1MHz		3.5		pF

Marking : LA

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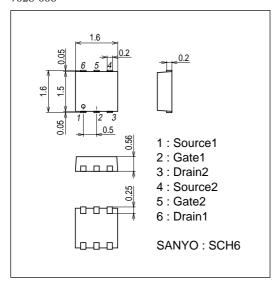
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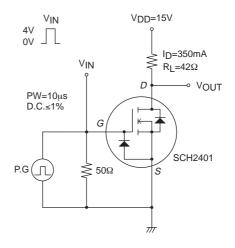
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		8		ns
Rise Time	tr	See specified Test Circuit.		6		ns
Turn-OFF Delay Time	td(off)	See specified Test Circuit.		10		ns
Fall Time	tf	See specified Test Circuit.		8		ns
Total Gate Charge	Qg	V _{DS} =10V, V _{GS} =10V, I _D =700mA		1		nC
Gate-to-Source Charge	Qgs	VDS=10V, VGS=10V, ID=700mA		0.4		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =10V, V _{GS} =10V, I _D =700mA		0.2		nC
Diode Forward Voltage	VSD	I _S =700mA, V _{GS} =0V		0.93	1.2	V

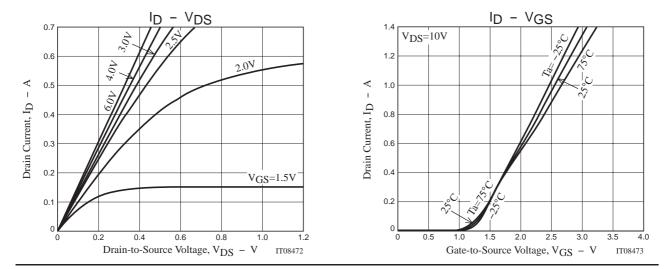
Package Dimensions

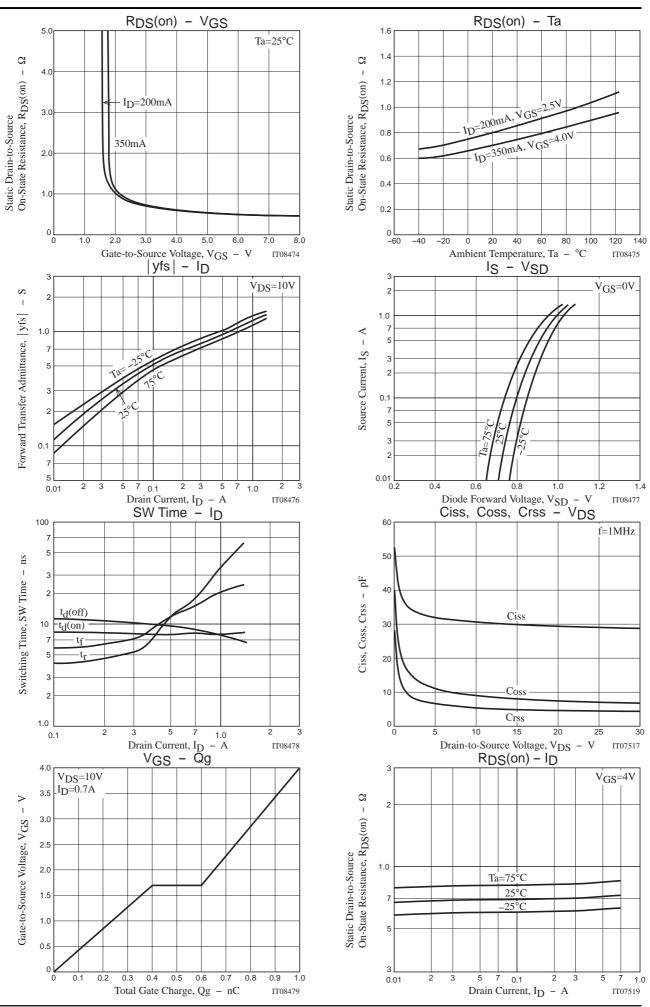
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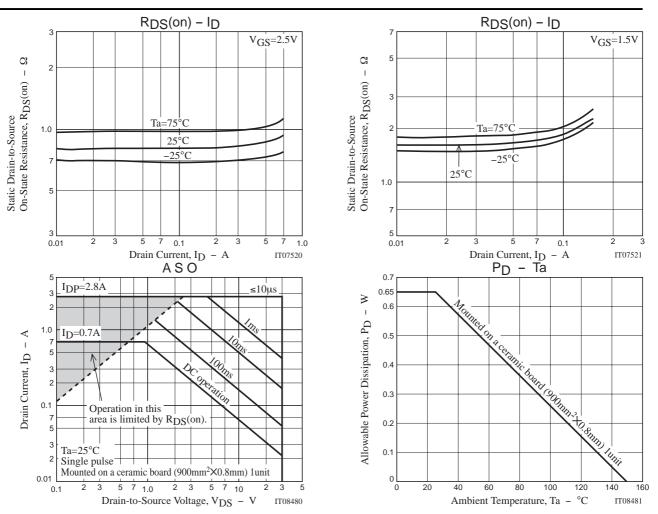


Switching Time Test Circuit









Note on usage : Since the SCH2401 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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